CONTENTS

products in the field of nanotechnologies. Much attention was paid for theoretical and practical aspects of projecting of nanoindustrial products and questions of cooperation of academician and institute science. Also were discussed the problems of commercialization of products in the field of nanoindustry and reducing the volume of financing of Federal Purpose Program (FPP) "The development of the infrastructure for the nanoindustry on 2008—2010".
Keywords: RAS, nanotechnologies, nanoindustry, FPP
Seleznev V. A., Prinz V. Ya., Korneev I. A. Chips with Semiconductor Tube-Probes for Scanning Tunnelling Microscopy
scopy (STM) is described. This method includes standard procedures of optical lithography and selective anisotropic etching of InP substrate, that leads to the formation of rolled-up tubes from strained $In_xGa_{1-x}As/In_yGa_{1-y}As$ heterofilms and simultaneous formation of chips. Created chips with semiconductor tube-probes are promising for high-vacuum scanning tunnelling microscopy and spectroscopy, spin tunnelling microscopy and near-field microscopy applications.
Keywords: scanning tunnelling microscopy, semiconductor tube-probes, self-rolling of strained heterofilms
Girfanova N. A. The Review and Comparison of Methods for Image Quality Detection is Passive Autofocusing Systems
Cridchin V. A., Lobach O. V., Dikareva R. P. Numerical Modeling of Microelectronic Heat Flux Sensor 13
The paper presents a simplified thermal and finite-element models of microelectronic heat flux sensor, features of a design are discussed. Thermal resistance is defined and expressions for a target signal of a sensor control are received. It is shown that the numerical simulation accurately describes the characteristics compared with the analytical model. A comparison of model calculations with experimental data, which confirmed the correctness of models. The proposed numerical model allows the optimization of the characteristics of the sensor. Keywords: sensor, heat flow, microelectronic technology, finite element method
Novikov S. G., Gurin N. T., Korneev I. V. Simulation and Investigation Negation with the Transfer N-Shaped Current-Voltage Characteristics
The paper presents a method of implementing embedded negatrons protection from current overload in the control circuit based on a combination of two elements with N-shaped volt-current characteristic. The features of appliances sold by this method are the existence of static output and transfer N-shaped CVC, as well as one or several chains of positive feedback, which allows to Limit the operating input current and output voltage within specified limits. Using this method will create a semiconductor structure with built-in protection against current overload in the control and load circuits. Keywords: negatrons, negative resistance, the transfer characteristic
Grinkin E. A., Babayevsky P. G., Zhukova S. A., Zhukov A. A., Obizhaev D. Yu. Effects of Regular Patterned
Polyimide Surfface Energy and Geometric Parameters on Water Sessile Drop Anisometry, Wetting Anisotropy and Contact Angle Hysteresis
Behavior of water sessile drop on polyimide surface with different surface energy values and two types of regular microtextures was investigated. Energy and geometrical factors defining drop form and effective contact angle in dependence on direction relative to given surface microtexture symmetry axes and surface slope were identified. Keywords: wetting, contact angle, polyimide, microstructured surfaces, specific free surface energy, anisotropy of wetting, wetting hysteresis, metastable state
HAHO W MWKDOCUCTEMHAG TEVHUKA NG A 2010

Rathkeen L. S. Nanotechnological Projects and Prospective Products of the Russian Academy of Science.... 2 In 2009 Russian academy of science (RAS), which celebrate the 286-th anniversary at 08.02.2010, organized specialized scientific sessions, on which, among the other questions, were discussed new projects and prospective

Sleptsov V. V., Tyanginsky A. Yu., Artjukhov S. A., Tserulev M. V. Definition of Concentration of Metals in Nanostructure Liquid Environments the Laser-Optical Method. Part 2. FUZZY Simulation
Smolin V. K. <i>Liquid Nitrogen Use for Forming Microelectronic Structures</i>
Agasiev A. A., Akhundov Ch. G., Mamedov M. Z., Sarmasov S. N., Mamedov H. M. <i>Nanostructural and Morphological Properties of SrTiO</i> ₃ <i>films</i>
Voytsehovsky A. V., Nesmelov S. N., Kulchitsky N. A., Melnikov A. A. Ge/Si Quantum Dot Detectors for an Infrared Range
Ehmenina I. V., Sheshin E. P., Chadaev N. N. Light Sources on Basis of Nanostructured Field-Emission Cathodes
Belozubov E. M. Thin-Film Capacitive Microelectromechanical Systems with the Monolithic Dielectric 48 Thin-film capacitive microelectromechanical systems (TCMEMS) with the monolithic dielectric are considered. The strength and weakness of such systems are indicated. Keywords: thin-film capacitive microelectromechanical systems (TCMEMS), the monolithic dielectric

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